TED-Kit 2

Release Notes

3.6.0 — December 5th, 2014

Document Information

Info	Content
Keywords	TED-Kit 2, Release Notes
Abstract	This document contains the release notes for the TED-Kit 2 software.

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1. Document Purpose

This document represents the release notes for the TED-Kit 2 system (consisting of software and hardware). It describes the major changes between the current and the last release which are considered to be relevant for the end user.

2. Components

The TED-Kit 2 system version 3.6.0 consists of the following components:

Table 1.   TED-Kit 2 Components

Name	Version	Description
GUI	3.6.0	The graphical user interface for the TED-Kit 2 API library.
API Library	4.1.0	The application programmer's interface to access the TED-Kit 2 hardware functionality.
FTDI Driver	2.12.00	The device driver for the TED-Kit 2 hardware.
Firmware	2.0	The firmware running on the TED-Kit 2 hardware.

3. Implemented Modifications

Details are listed below:

3.1 GUI

The following modifications were implemented in the GUI:

- SC48211:Unexpected communication failures reported by customers
- SC48804:WFS5c: introduce PAIR command in tedkit2 gui.
- SC49290:Show device driver version in hex
- SC49268:WFS5c: PING command does not show correct device mode PROECTED

3.2 API

The following modifications were implemented in the API:

- Added support for WFS-5c PAIR command

3.3 Miscellaneous

The following modifications were implemented in other components:

- SC48849:Update the TED-Kit 2 device driver

4. Interface Changes

No changes compared to the previous version.

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